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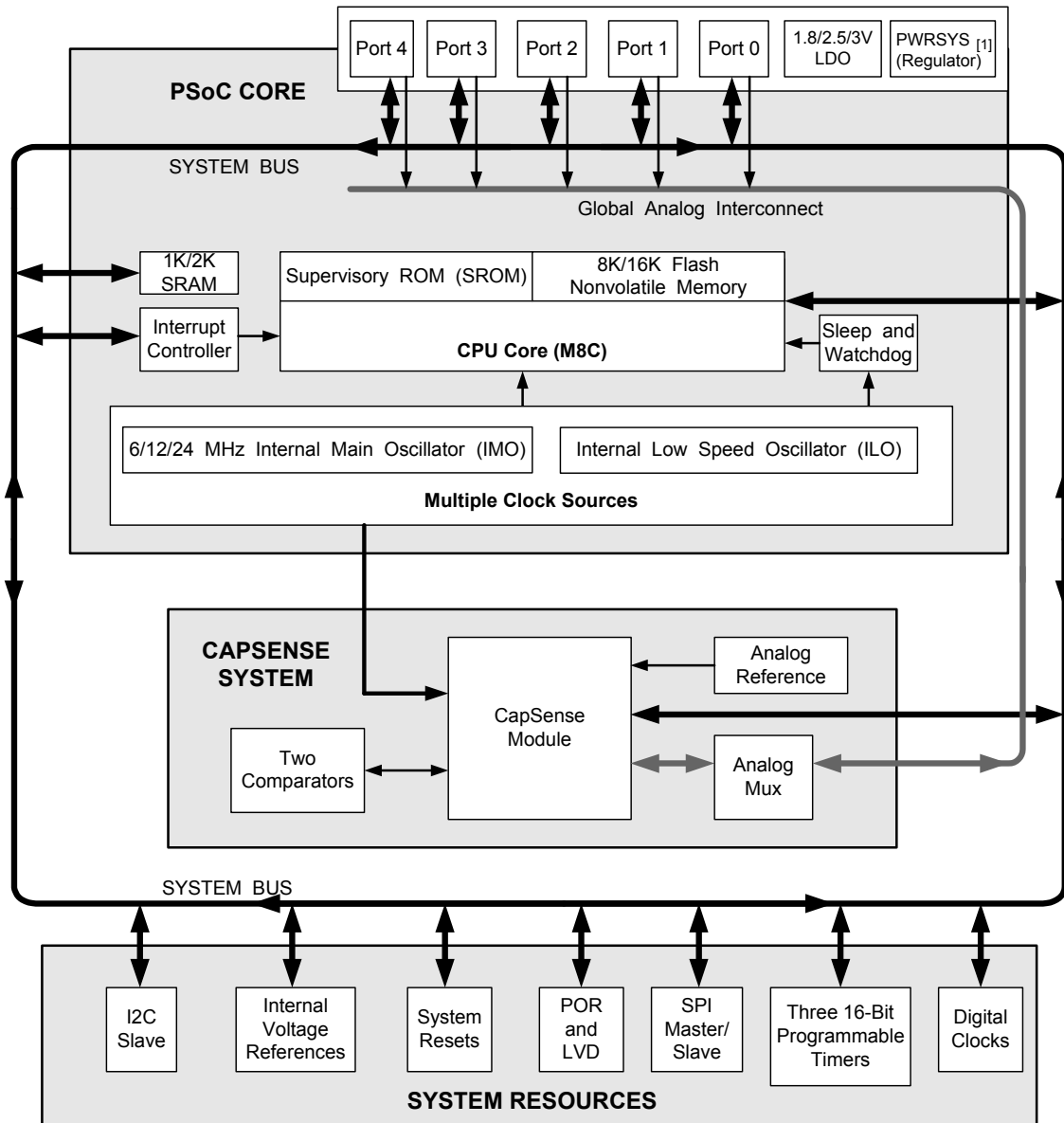
What Are [Embedded - Microcontrollers - Application Specific](#)?

Application specific microcontrollers are engineered to

Details

Product Status	Obsolete
Applications	Capacitive Sensing
Core Processor	M8C
Program Memory Type	FLASH (32kB)
Controller Series	CY8C20xx6A
RAM Size	2K x 8
Interface	I ² C, SPI, USB
Number of I/O	36
Voltage - Supply	1.71V ~ 5.5V
Operating Temperature	-40°C ~ 85°C
Mounting Type	Surface Mount
Package / Case	48-VFQFN Exposed Pad
Supplier Device Package	48-QFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c20066a-24ltxit

Logic Block Diagram



Note

1. Internal voltage regulator for internal circuitry

Contents

PSoC® Functional Overview	4	AC Chip-Level Specifications	18
PSoC Core	4	AC General Purpose I/O Specifications	19
CapSense System	4	AC Comparator Specifications	20
Haptics TS2000 Controller	4	AC External Clock Specifications	20
Additional System Resources	5	AC Programming Specifications	21
Getting Started	5	AC I2C Specifications	22
Application Notes	5	Packaging Information	26
Development Kits	5	Thermal Impedances	28
Training	5	Capacitance on Crystal Pins	28
CYPs Consultants	5	Solder Reflow Peak Temperature	28
Solutions Library	5	Development Tool Selection	29
Technical Support	5	Software	29
Development Tools	6	Development Kits	29
PSoC Designer Software Subsystems	6	Evaluation Tools	29
Designing with PSoC Designer	7	Device Programmers	30
Select User Modules	7	Accessories (Emulation and Programming)	30
Configure User Modules	7	Third Party Tools	30
Organize and Connect	7	Build a PSoC Emulator into Your Board	30
Generate, Verify, and Debug	7	Ordering Information	31
Pinouts	8	Ordering Code Definitions	31
24-Pin QFN	8	Document Conventions	32
32-Pin QFN	9	Acronyms Used	32
48-Pin QFN OCD	10	Units of Measure	32
Electrical Specifications	11	Numeric Naming	32
Absolute Maximum Ratings	11	Glossary	33
Operating Temperature	11	Reference Documents	33
DC Chip-Level Specifications	12	Document History Page	34
DC General Purpose I/O Specifications	13	Sales, Solutions, and Legal Information	35
DC Analog Mux Bus Specifications	15	Worldwide Sales and Design Support	35
DC Low Power Comparator Specifications	15	Products	35
Comparator User Module Electrical Specifications	16	PSoC Solutions	35
ADC Electrical Specifications	16		
DC POR and LVD Specifications	17		
DC Programming Specifications	17		

PSoC® Functional Overview

The PSoC family consists of on-chip controller devices, which are designed to replace multiple traditional microcontroller unit (MCU)-based components with one, low-cost single-chip programmable component. A PSoC device includes configurable analog and digital blocks, and programmable interconnect. This architecture allows the user to create customized peripheral configurations, to match the requirements of each individual application. Additionally, a fast CPU, flash program memory, SRAM data memory, and configurable I/O are included in a range of convenient pinouts.

The architecture for this device family, as shown in the [Logic Block Diagram on page 2](#), consists of three main areas:

- The core
- CapSense analog system
- System resources (including a full-speed USB port).

A common, versatile bus allows connection between the I/O and the analog system.

Each CY8C20336H/446H PSoC device includes a dedicated CapSense block that provides sensing and scanning control circuitry for capacitive sensing applications. Depending on the PSoC package, up to 28 GPIOs are also included. The GPIOs provide access to the MCU and analog mux.

PSoC Core

The PSoC core is a powerful engine that supports a rich instruction set. It encompasses SRAM for data storage, an interrupt controller, sleep and watchdog timers, and IMO and ILO. The CPU core, called the M8C, is a powerful processor with speeds up to 24 MHz. The M8C is a 4-MIPS, 8-bit Harvard-architecture microprocessor.

CapSense System

The analog system contains the capacitive sensing hardware. Several hardware algorithms are supported. This hardware performs capacitive sensing and scanning without requiring external components. The analog system is composed of the CapSense PSoC block and an internal 1-V or 1.2-V analog reference, which together support capacitive sensing of up to 28 inputs^[2]. Capacitive sensing is configurable on each GPIO pin. Scanning of enabled CapSense pins are completed quickly and easily across multiple ports.

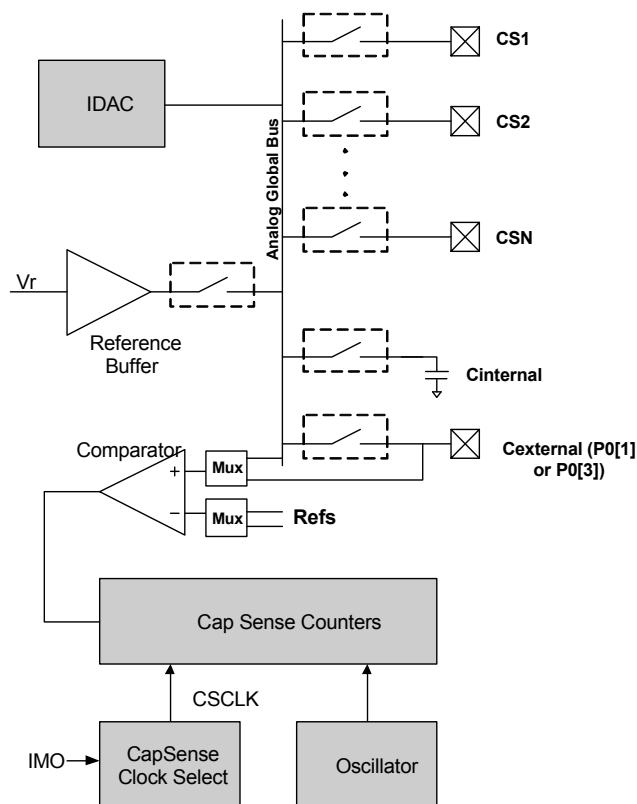
SmartSense™

SmartSense is an innovative solution from Cypress that removes manual tuning of CapSense applications. This solution is easy-to-use and provides a robust noise immunity. It is the only auto-tuning solution that establishes, monitors, and maintains all required tuning parameters. SmartSense allows engineers to go from prototyping to mass production without re-tuning for manufacturing variations in PCB and/or overlay material properties.

Note

2. 36 GPIOs = 33 pins for capacitive sensing + 2 pins for I²C + 1 pin for modulator capacitor.

Figure 1. CapSense System Block Diagram



Analog Multiplexer System

The analog mux bus can connect to every GPIO pin. Pins are connected to the bus individually or in any combination. The bus also connects to the analog system for analysis with the CapSense block comparator.

Switch-control logic enables selected pins to precharge continuously under hardware control. This enables capacitive measurement for applications such as touch sensing. Other multiplexer applications include:

- Complex capacitive sensing interfaces, such as sliders and touchpads.
- Chip-wide mux that allows analog input from any I/O pin.
- [Crosspoint connection](#) between any I/O pin combinations.

Haptics TS2000 Controller

The CY8C20336H/CY8C20446H family of devices feature an easy-to-use Haptics controller resource with up to 14 different effects. These effects are available for use with three different, selectable ERM modules.

Additional System Resources

System resources provide additional capability, such as configurable USB and I²C slave, SPI master/slave communication interface, three 16-bit programmable timers, and various system resets supported by the M8C.

These system resources provide additional capability useful to complete systems. Additional resources include low voltage detection and power on reset. The merits of each system resource are listed here:

- The I²C slave/SPI master-slave module provides 50/100/400 kHz communication over two wires. SPI communication over three or four wires runs at speeds of 46.9 kHz to 3 MHz (lower for a slower system clock).
- The I²C hardware address recognition feature reduces the already low power consumption by eliminating the need for CPU intervention until a packet addressed to the target device is received.
- The I²C enhanced slave interface appears as a 32-byte RAM buffer to the external I²C master. Using a simple predefined protocol, the master controls the read and write pointers into the RAM. When this method is enabled, the slave does not stall the bus when receiving data bytes in active mode. For usage details, refer to the application note [I2C Enhanced Slave Operation - AN56007](#).
- Low voltage detection (LVD) interrupts can signal the application of falling voltage levels, while the advanced power-on-reset (POR) circuit eliminates the need for a system supervisor.
- An internal reference provides an absolute reference for capacitive sensing.
- A register-controlled bypass mode allows the user to disable the LDO regulator.

Getting Started

For in depth information, along with detailed programming details, see the PSoC® [Technical Reference Manual](#).

For up-to-date ordering, packaging, and electrical specification information, see the latest [PSoC device datasheets](#) on the web.

Application Notes

[Cypress application notes](#) are an excellent introduction to the wide variety of possible PSoC designs.

Development Kits

[PSoC Development Kits](#) are available online from and through a growing number of regional and global distributors, which include Arrow, Avnet, Digi-Key, Farnell, Future Electronics, and Newark.

Training

[Free PSoC technical training](#) (on demand, webinars, and workshops), which is available online via www.cypress.com, covers a wide variety of topics and skill levels to assist you in your designs.

CYPros Consultants

Certified PSoC consultants offer everything from technical assistance to completed PSoC designs. To contact or become a PSoC consultant go to the [CYPros Consultants](#) web site.

Solutions Library

Visit our growing [library of solution focused designs](#). Here you can find various application designs that include firmware and hardware design files that enable you to complete your designs quickly.

Technical Support

[Technical support](#) – including a searchable Knowledge Base articles and technical forums – is also available online. If you cannot find an answer to your question, call our Technical Support hotline at 1-800-541-4736.

Development Tools

PSoC Designer™ is the revolutionary integrated design environment (IDE) that you can use to customize PSoC to meet your specific application requirements. PSoC Designer software accelerates system design and time to market. Develop your applications using a library of precharacterized analog and digital peripherals (called user modules) in a drag-and-drop design environment. Then, customize your design by leveraging the dynamically generated application programming interface (API) libraries of code. Finally, debug and test your designs with the integrated debug environment, including in-circuit emulation and standard software debug features. PSoC Designer includes:

- Application editor graphical user interface (GUI) for device and user module configuration and dynamic reconfiguration
- Extensive user module catalog
- Integrated source-code editor (C and assembly)
- Free C compiler with no size restrictions or time limits
- Built-in debugger
- In-circuit emulation
- Built-in support for communication interfaces:
 - Hardware and software I²C slaves and masters
 - Full-speed USB 2.0
 - Up to four full-duplex universal asynchronous receiver/transmitters (UARTs), SPI master and slave, and wireless

PSoC Designer supports the entire library of PSoC 1 devices and runs on Windows XP, Windows Vista, and Windows 7.

PSoC Designer Software Subsystems

Design Entry

In the chip-level view, choose a base device to work with. Then select different onboard analog and digital components that use the PSoC blocks, which are called user modules. Examples of user modules are analog-to-digital converters (ADCs), digital-to-analog converters (DACs), amplifiers, and filters. Configure the user modules for your chosen application and connect them to each other and to the proper pins. Then generate your project. This prepopulates your project with APIs and libraries that you can use to program your application.

The tool also supports easy development of multiple configurations and dynamic reconfiguration. Dynamic reconfiguration makes it possible to change configurations at run time. In essence, this lets you to use more than 100 percent of PSoC's resources for an application.

Code Generation Tools

The code generation tools work seamlessly within the PSoC Designer interface and have been tested with a full range of debugging tools. You can develop your design in C, assembly, or a combination of the two.

Assemblers. The assemblers allow you to merge assembly code seamlessly with C code. Link libraries automatically use absolute addressing or are compiled in relative mode, and linked with other software modules to get absolute addressing.

C Language Compilers. C language compilers are available that support the PSoC family of devices. The products allow you to create complete C programs for the PSoC family devices. The optimizing C compilers provide all of the features of C, tailored to the PSoC architecture. They come complete with embedded libraries providing port and bus operations, standard keypad and display support, and extended math functionality.

Debugger

PSoC Designer has a debug environment that provides hardware in-circuit emulation, allowing you to test the program in a physical system while providing an internal view of the PSoC device. Debugger commands allow you to read and program and read and write data memory, and read and write I/O registers. You can read and write CPU registers, set and clear breakpoints, and provide program run, halt, and step control. The debugger also lets you to create a trace buffer of registers and memory locations of interest.

Online Help System

The online help system displays online, context-sensitive help. Designed for procedural and quick reference, each functional subsystem has its own context-sensitive help. This system also provides tutorials and links to FAQs and an Online Support Forum to aid the designer.

In-Circuit Emulator

A low-cost, high-functionality in-circuit emulator (ICE) is available for development support. This hardware can program single devices.

The emulator consists of a base unit that connects to the PC using a USB port. The base unit is universal and operates with all PSoC devices. Emulation pods for each device family are available separately. The emulation pod takes the place of the PSoC device in the target board and performs full-speed (24 MHz) operation.

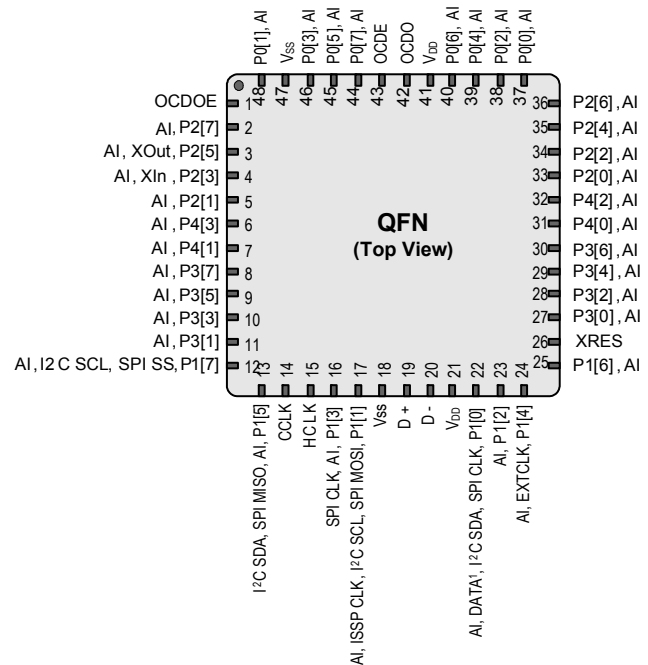
48-Pin QFN OCD

The 48-pin QFN part is for the CY8C20066A On-Chip Debug (OCD) PSoC device. Note that this part is only used for in-circuit debugging.^[9]

Table 3. Pin Definitions - CY8C20066A PSoC Device ^[10, 11]

Pin No.	Digital	Analog	Name	Description
1			OCDOE	OCD mode direction pin
2	I/O	I	P2[7]	
3	I/O	I	P2[5]	Crystal output (XOut)
4	I/O	I	P2[3]	Crystal input (XIn)
5	I/O	I	P2[1]	
6	I/O	I	P4[3]	
7	I/O	I	P4[1]	
8	I/O	I	P3[7]	
9	I/O	I	P3[5]	
10	I/O	I	P3[3]	
11	I/O	I	P3[1]	
12	IOHR	I	P1[7]	I ² C SCL, SPI SS
13	IOHR	I	P1[5]	I ² C SDA, SPI MISO
14			CCLK	OCD CPU clock output
15			HCLK	OCD high speed clock output
16	IOHR	I	P1[3]	SPI CLK.
17	IOHR	I	P1[1]	ISSP CLK ^[12] , I ² C SCL, SPI MOSI
18	Power		Vss	Ground connection
19	I/O		D+	USB D+
20	I/O		D-	USB D-
21	Power		V _{DD}	Supply voltage
22	IOHR	I	P1[0]	ISSP DATA ^[12] , I ² C SDA, SPI CLK
23	IOHR	I	P1[2]	
24	IOHR	I	P1[4]	Optional external clock input (EXTCLK)
25	IOHR	I	P1[6]	
26	Input		XRES	Active high external reset with internal pull down
27	I/O	I	P3[0]	
28	I/O	I	P3[2]	
29	I/O	I	P3[4]	
30	I/O	I	P3[6]	
31	I/O	I	P4[0]	
32	I/O	I	P4[2]	
33	I/O	I	P2[0]	
34	I/O	I	P2[2]	
35	I/O	I	P2[4]	
36	I/O	I	P2[6]	

Figure 4. CY8C20066A PSoC Device



Pin No.	Digital	Analog	Name	Description
37	IOH	I	P0[0]	
38	IOH	I	P0[2]	
39	IOH	I	P0[4]	
40	IOH	I	P0[6]	
41	Power		V _{DD}	Supply voltage
42			OCDO	OCD even data I/O
43			OCDE	OCD odd data output
44	IOH	I	P0[7]	
45	IOH	I	P0[5]	
46	IOH	I	P0[3]	Integrating input
47	Power		V _{SS}	Ground connection
48	IOH	I	P0[1]	
CP	Power		V _{SS}	Center pad must be connected to ground

LEGEND A = Analog, I = Input, O = Output, NC = No Connection H = 5 mA High Output Drive, R = Regulated Output.

Notes

9. This part is available in limited quantities for In-Circuit Debugging during prototype development. It is not available in production volumes.
10. During power-up or reset event, device P1[1] and P1[0] may disturb the I²C bus. Use alternate pins if you encounter any issues.
11. The center pad (CP) on the QFN package must be connected to ground (Vss) for best mechanical, thermal, and electrical performance. If not connected to ground, it must be electrically floated and not connected to any other signal.
12. These are the ISSP pins, which are not High Z at power on reset (POR).

DC Chip-Level Specifications

The following table lists guaranteed maximum and minimum specifications for the entire voltage and temperature ranges.

Table 6. DC Chip-Level Specifications

Symbol	Description	Conditions	Min	Typ	Max	Units
$V_{DD}^{[13]}$	Supply voltage	Refer the table DC POR and LVD Specifications on page 17	1.71	–	5.50	V
I_{DD24}	Supply current, IMO = 24 MHz	Conditions are $V_{DD} \leq 3.0$ V, $T_A = 25$ °C, CPU = 24 MHz. CapSense running at 12 MHz, no I/O sourcing current	–	3.32	4.00	mA
I_{DD12}	Supply current, IMO = 12 MHz	Conditions are $V_{DD} \leq 3.0$ V, $T_A = 25$ °C, CPU = 12 MHz. CapSense running at 12 MHz, no I/O sourcing current	–	1.86	2.60	mA
I_{DD6}	Supply current, IMO = 6 MHz	Conditions are $V_{DD} \leq 3.0$ V, $T_A = 25$ °C, CPU = 6 MHz. CapSense running at 6 MHz, no I/O sourcing current	–	1.13	1.80	mA
I_{SB0}	Deep sleep current	$V_{DD} \leq 3.0$ V, $T_A = 25$ °C, I/O regulator turned off	–	0.10	0.50	μA
I_{SB1}	Standby current with POR, LVD, and sleep timer	$V_{DD} \leq 3.0$ V, $T_A = 25$ °C, I/O regulator turned off	–	1.07	1.50	μA

Note

13. When V_{DD} remains in the range from 1.71 V to 1.9 V for more than 50 μsec, the slew rate when moving from the 1.71 V to 1.9 V range to greater than 2 V must be slower than 1 V/500 μsec to avoid triggering POR. The only other restriction on slew rates for any other voltage range or transition is the SR_{POWER_UP} parameter.

Table 8. 2.4 V to 3.0 V DC GPIO Specifications

Symbol	Description	Conditions	Min	Typ	Max	Units
R _{PU}	Pull-up resistor		4	5.60	8	kΩ
V _{OH1}	High output voltage port 2 or 3 pins	I _{OH} < 10 μA, maximum of 10 mA source current in all I/Os	V _{DD} – 0.20	–	–	V
V _{OH2}	High output voltage port 2 or 3 pins	I _{OH} = 0.2 mA, maximum of 10 mA source current in all I/Os	V _{DD} – 0.40	–	–	V
V _{OH3}	High output voltage port 0 or 1 pins with LDO regulator disabled for port 1	I _{OH} < 10 μA, maximum of 10 mA source current in all I/Os	V _{DD} – 0.20	–	–	V
V _{OH4}	High output voltage port 0 or 1 pins with LDO regulator disabled for port 1	I _{OH} = 2 mA, maximum of 10 mA source current in all I/Os	V _{DD} – 0.50	–	–	V
V _{OH5A}	High output voltage port 1 pins with LDO enabled for 1.8 V out	I _{OH} < 10 μA, V _{DD} > 2.4 V, maximum of 20 mA source current in all I/Os	1.50	1.80	2.10	V
V _{OH6A}	High output voltage port 1 pins with LDO enabled for 1.8 V out	I _{OH} = 1 mA, V _{DD} > 2.4 V, maximum of 20 mA source current in all I/Os	1.20	–	–	V
V _{OL}	Low output voltage	I _{OL} = 10 mA, maximum of 30 mA sink current on even port pins (for example, P0[2] and P1[4]) and 30 mA sink current on odd port pins (for example, P0[3] and P1[5])	–	–	0.75	V
V _{IL}	Input low voltage		–	–	0.72	V
V _{IH}	Input high voltage		1.40	–	–	V
V _H	Input hysteresis voltage		–	80	–	mV
I _{IL}	Input leakage (absolute value)		–	1	1000	nA
C _{PIN}	Capacitive load on pins	Package and pin dependent Temp = 25 °C	0.50	1.70	7	pF

Table 9. 1.71 V to 2.4 V DC GPIO Specifications

Symbol	Description	Conditions	Min	Typ	Max	Units
R _{PU}	Pull-up resistor		4	5.60	8	kΩ
V _{OH1}	High output voltage port 2 or 3 pins	I _{OH} = 10 μA, maximum of 10 mA source current in all I/Os	V _{DD} – 0.20	–	–	V
V _{OH2}	High output voltage port 2 or 3 pins	I _{OH} = 0.5 mA, maximum of 10 mA source current in all I/Os	V _{DD} – 0.50	–	–	V
V _{OH3}	High output voltage port 0 or 1 pins with LDO regulator disabled for port 1	I _{OH} = 100 μA, maximum of 10 mA source current in all I/Os	V _{DD} – 0.20	–	–	V
V _{OH4}	High output voltage port 0 or 1 pins with LDO regulator disabled for port 1	I _{OH} = 2 mA, maximum of 10 mA source current in all I/Os	V _{DD} – 0.50	–	–	V
V _{OL}	Low output voltage	I _{OL} = 5 mA, maximum of 20 mA sink current on even port pins (for example, P0[2] and P1[4]) and 30 mA sink current on odd port pins (for example, P0[3] and P1[5])	–	–	0.40	V
V _{IL}	Input low voltage		–	–	0.30 × V _{DD}	V
V _{IH}	Input high voltage		0.65 × V _{DD}	–	–	V

Comparator User Module Electrical Specifications

The following table lists the guaranteed maximum and minimum specifications. Unless stated otherwise, the specifications are for the entire device voltage and temperature operating range: $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, $1.71\text{ V} \leq V_{DD} \leq 5.5\text{ V}$.

Table 13. Comparator User Module Electrical Specifications

Symbol	Description	Conditions	Min	Typ	Max	Units
T_{COMP}	Comparator response time	50-mV overdrive	–	70	100	ns
Offset		Valid from 0.2 V to $V_{DD} - 0.2\text{ V}$	–	2.5	30	mV
Current		Average DC current, 50 mV overdrive	–	20	80	μA
PSRR	Supply voltage > 2 V	Power supply rejection ratio	–	80	–	dB
	Supply voltage < 2 V	Power supply rejection ratio	–	40	–	dB
Input Range			0	–	1.5	V

ADC Electrical Specifications

Table 14. ADC User Module Electrical Specifications

Symbol	Description	Conditions	Min	Typ	Max	Units
Input						
V_{IN}	Input voltage range		0	–	V_{REFADC}	V
C_{IIN}	Input capacitance		–	–	5	pF
R_{IN}	Input resistance	Equivalent switched cap input resistance for 8-, 9-, or 10-bit resolution	$1/(500\text{fF} \times \text{data clock})$	$1/(400\text{fF} \times \text{data clock})$	$1/(300\text{fF} \times \text{data clock})$	Ω
Reference						
V_{REFADC}	ADC reference voltage		1.14	–	1.26	V
Conversion Rate						
F_{CLK}	Data clock	Source is chip's internal main oscillator. See AC Chip-Level Specifications on page 18 for accuracy	2.25	–	6	MHz
S8	8-bit sample rate	Data clock set to 6 MHz. Sample Rate = $0.001/(2^{\text{Resolution}}/\text{Data clock})$	–	23.43	–	ksps
S10	10-bit sample rate	Data clock set to 6 MHz. Sample Rate = $0.001/(2^{\text{Resolution}}/\text{Data clock})$	–	5.85	–	ksps
DC Accuracy						
RES	Resolution	Can be set to 8-, 9-, or 10-bit	8	–	10	bits
DNL	Differential nonlinearity		–1	–	+2	LSB
INL	Integral nonlinearity		–2	–	+2	LSB
E_{OFFSET}	Offset error	8-bit resolution	0	3.20	19.20	LSB
		10-bit resolution	0	12.80	76.80	LSB
E_{GAIN}	Gain error	For any resolution	–5	–	+5	%FSR
Power						
I_{ADC}	Operating current		–	2.10	2.60	mA
PSRR	Power supply rejection ratio	PSRR ($V_{DD} > 3.0\text{ V}$)	–	24	–	dB
		PSRR ($V_{DD} < 3.0\text{ V}$)	–	30	–	dB

DC POR and LVD Specifications

The following table lists guaranteed maximum and minimum specifications for the entire voltage and temperature ranges.

Table 15. DC POR and LVD Specifications

Symbol	Description	Conditions	Min	Typ	Max	Units
V _{POR0}	1.66 V selected in PSoC Designer	V _{DD} must be greater than or equal to 1.71 V during startup, reset from the XRES pin, or reset from watchdog.	1.61	1.66	1.71	V
V _{POR1}	2.36 V selected in PSoC Designer		–	2.36	2.41	
V _{POR2}	2.60 V selected in PSoC Designer		–	2.60	2.66	
V _{POR3}	2.82 V selected in PSoC Designer		–	2.82	2.95	
V _{LVD0}	2.45 V selected in PSoC Designer		2.40	2.45	2.51	V
V _{LVD1}	2.71 V selected in PSoC Designer		2.64 ^[14]	2.71	2.78	
V _{LVD2}	2.92 V selected in PSoC Designer		2.85 ^[15]	2.92	2.99	
V _{LVD3}	3.02 V selected in PSoC Designer		2.95 ^[16]	3.02	3.09	
V _{LVD4}	3.13 V selected in PSoC Designer		3.06	3.13	3.20	
V _{LVD5}	1.90 V selected in PSoC Designer		1.84	1.90	2.32	
V _{LVD6}	1.80 V selected in PSoC Designer		1.75 ^[17]	1.80	1.84	
V _{LVD7}	4.73 V selected in PSoC Designer		4.62	4.73	4.83	

DC Programming Specifications

The following table lists guaranteed maximum and minimum specifications for the entire voltage and temperature ranges.

Table 16. DC Programming Specifications

Symbol	Description	Conditions	Min	Typ	Max	Units
V _{DDIWRITE}	Supply voltage for flash write operations		1.71	–	5.25	V
I _{DDP}	Supply current during programming or verify		–	5	25	mA
V _{ILP}	Input low voltage during programming or verify	See the appropriate DC General Purpose I/O Specifications on page 13	–	–	V _{IL}	V
V _{IHP}	Input high voltage during programming or verify	See appropriate DC General Purpose I/O Specifications on page 13 table on pages 15 or 16	V _{IH}	–	–	V
I _{ILP}	Input current when applying V _{ILP} to P1[0] or P1[1] during programming or verify	Driving internal pull-down resistor	–	–	0.2	mA
I _{IHP}	Input current when applying V _{IHP} to P1[0] or P1[1] during programming or verify	Driving internal pull-down resistor	–	–	1.5	mA
V _{OLP}	Output low voltage during programming or verify		–	–	V _{SS} + 0.75	V
V _{OHP}	Output high voltage during programming or verify	See appropriate DC General Purpose I/O Specifications on page 13 table on page 16. For V _{DD} > 3 V use V _{OH4} in Table 5 on page 11 .	V _{OH}	–	V _{DD}	V
Flash _{ENPB}	Flash write endurance	Erase/write cycles per block	50,000	–	–	–
Flash _{DR}	Flash data retention	Following maximum flash write cycles; ambient temperature of 55 °C	10	20	–	Years

Notes

14. Always greater than 50 mV above V_{PPOR1} voltage for falling supply.
15. Always greater than 50 mV above V_{PPOR2} voltage for falling supply.
16. Always greater than 50 mV above V_{PPOR3} voltage for falling supply.
17. Always greater than 50 mV above V_{PPOR0} voltage for falling supply.

Table 19. AC Characteristics – USB Data Timings

Symbol	Description	Conditions	Min	Typ	Max	Units
T _{DRATE}	Full-speed data rate	Average bit rate	12 – 0.25%	12	12 + 0.25%	MHz
T _{JR1}	Receiver jitter tolerance	To next transition	–18.5	–	18.5	ns
T _{JR2}	Receiver jitter tolerance	To pair transition	–9	–	9	ns
T _{DJ1}	FS driver jitter	To next transition	–3.5	–	3.5	ns
T _{DJ2}	FS driver jitter	To pair transition	–4.0	–	4.0	ns
T _{FDEOP}	Source jitter for differential transition	To SE0 transition	–2	–	5	ns
T _{FEOPT}	Source SE0 interval of EOP		160	–	175	ns
T _{FEOPR}	Receiver SE0 interval of EOP		82	–		ns
T _{FST}	Width of SE0 interval during differential transition		–	–	14	ns

Table 20. AC Characteristics – USB Driver

Symbol	Description	Conditions	Min	Typ	Max	Units
T _{FR}	Transition rise time	50 pF	4	–	20	ns
T _{FF}	Transition fall time	50 pF	4	–	20	ns
T _{FRFM} ^[19]	Rise/fall time matching		90	–	111	%
V _{crs}	Output signal crossover voltage		1.30	–	2.00	V

AC Comparator Specifications

The following table lists guaranteed maximum and minimum specifications for the entire voltage and temperature ranges.

Table 21. AC Low Power Comparator Specifications

Symbol	Description	Conditions	Min	Typ	Max	Units
T _{LPC}	Comparator response time, 50 mV overdrive	50 mV overdrive does not include offset voltage.	–	–	100	ns

AC External Clock Specifications

The following table lists guaranteed maximum and minimum specifications for the entire voltage and temperature ranges.

Table 22. AC External Clock Specifications

Symbol	Description	Conditions	Min	Typ	Max	Units
F _{OSCEXT}	Frequency (external oscillator frequency)		0.75	–	25.20	MHz
	High period		20.60	–	5300	ns
	Low period		20.60	–	–	ns
	Power-up IMO to switch		150	–	–	μs

Note

19. T_{FRFM} is not met under all conditions. There is a corner case at lower supply voltages, such as those under 3.3 V. This condition does not affect USB communications. Signal integrity tests show an excellent eye diagram at 3.15 V.

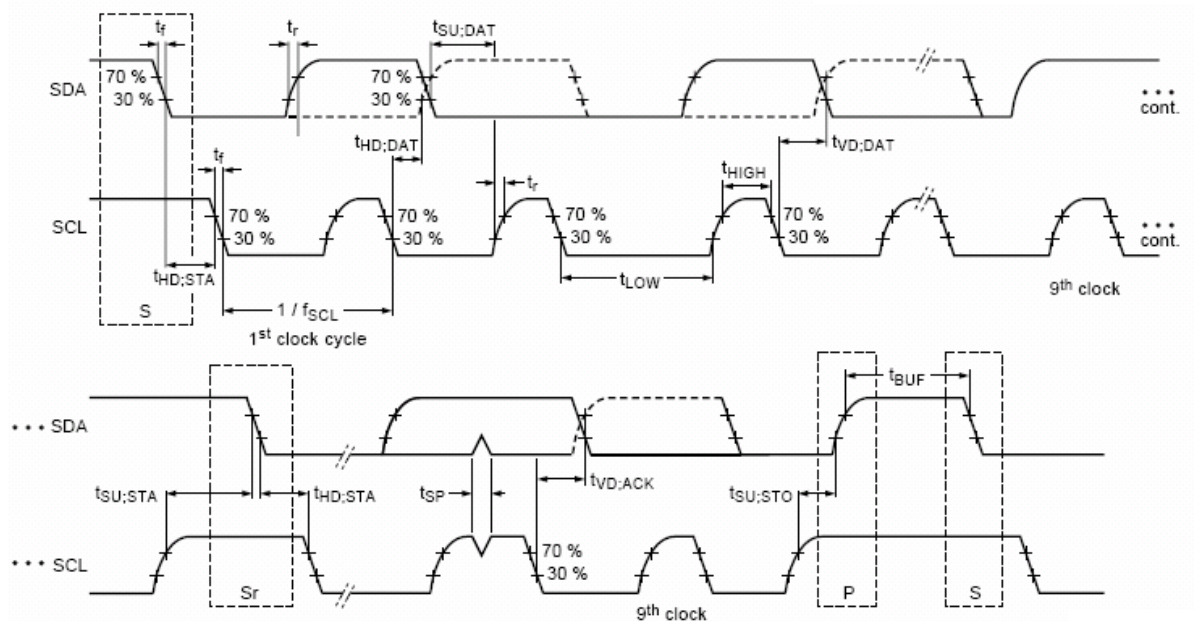
AC I²C Specifications

The following table lists guaranteed maximum and minimum specifications for the entire voltage and temperature ranges.

Table 24. AC Characteristics of the I²C SDA and SCL Pins

Symbol	Description	Standard Mode		Fast Mode		Units
		Min	Max	Min	Max	
f_{SCL}	SCL clock frequency	0	100	0	400	kHz
$t_{HD;STA}$	Hold time (repeated) START condition. After this period, the first clock pulse is generated.	4.0	—	0.6	—	μ s
t_{LOW}	LOW period of the SCL clock	4.7	—	1.3	—	μ s
t_{HIGH}	HIGH period of the SCL clock	4.0	—	0.6	—	μ s
$t_{SU;STA}$	Setup time for a repeated START condition	4.7	—	0.6	—	μ s
$t_{HD;DAT}$	Data hold time	0	3.45	0	0.9	μ s
$t_{SU;DAT}$	Data setup time	250	—	100 ^[20]	—	ns
$t_{SU;STO}$	Setup time for STOP condition	4.0	—	0.6	—	μ s
t_{BUF}	Bus-free time between a STOP and START condition	4.7	—	1.3	—	μ s
t_{SP}	Pulse width of spikes are suppressed by the input filter.	—	—	0	50	ns

Figure 8. Definition for Timing for Fast/Standard Mode on the I²C Bus



Note

20. A Fast-Mode I²C-bus device can be used in a Standard Mode I²C-bus system, but the requirement $t_{SU;DAT} \geq 250$ ns must then be met. This automatically be the case if the device does not stretch the LOW period of the SCL signal. If such device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line $t_{rmax} + t_{SU;DAT} = 1000 + 250 = 1250$ ns (according to the Standard-Mode I²C-bus specification) before the SCL line is released.

Figure 11. SPI Slave Mode 0 and 2

SPI Slave, modes 0 and 2

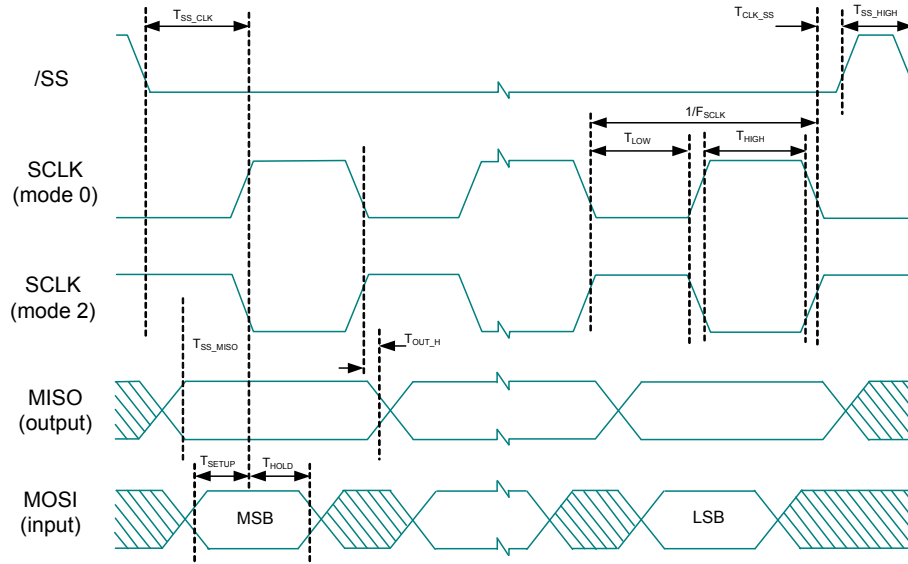
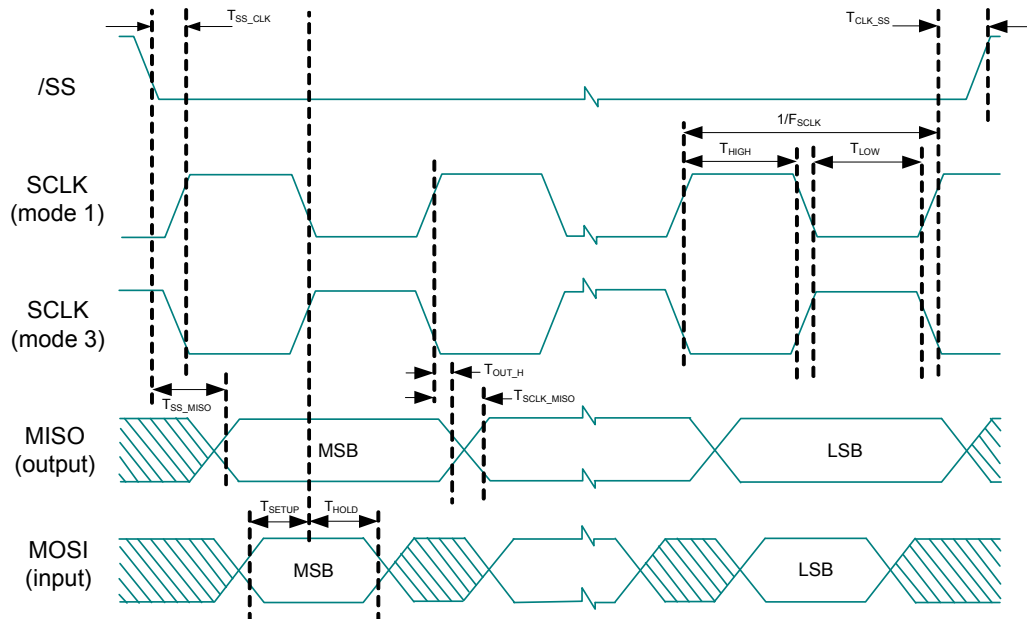


Figure 12. SPI Slave Mode 1 and 3

SPI Slave, modes 1 and 3

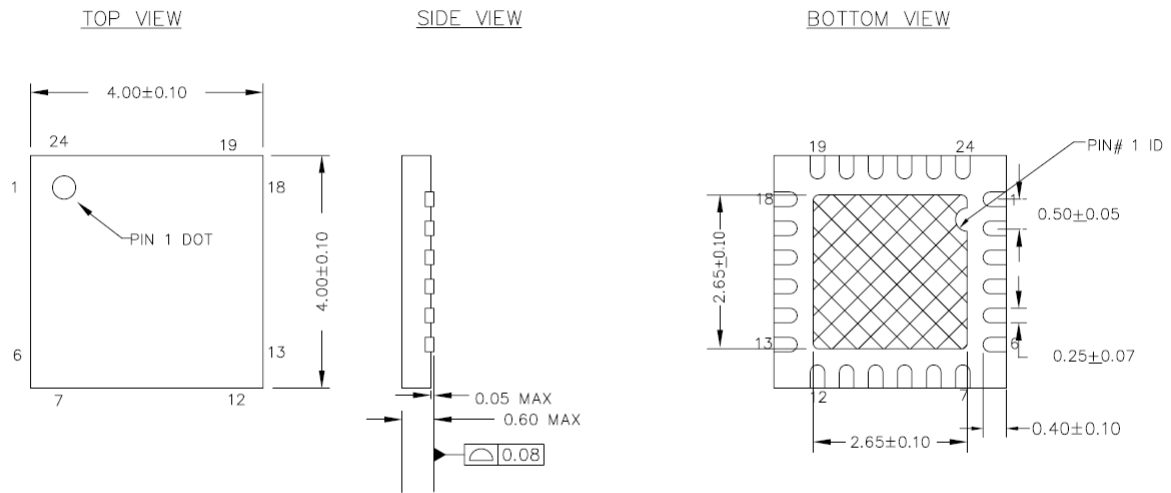


Packaging Information


This section illustrates the packaging specifications for the CY8C20336H/CY8C20446H PSoC device, along with the thermal impedances for each package.

Important Note Emulation tools may require a larger area on the target PCB than the chip's footprint. For a detailed description of the emulation tools' dimensions, refer to the document titled *PSoC Emulator Pod Dimensions* at <http://www.cypress.com/design/MR10161>.

Figure 13. 24-Pin ($4 \times 4 \times 0.55$ mm) QFN

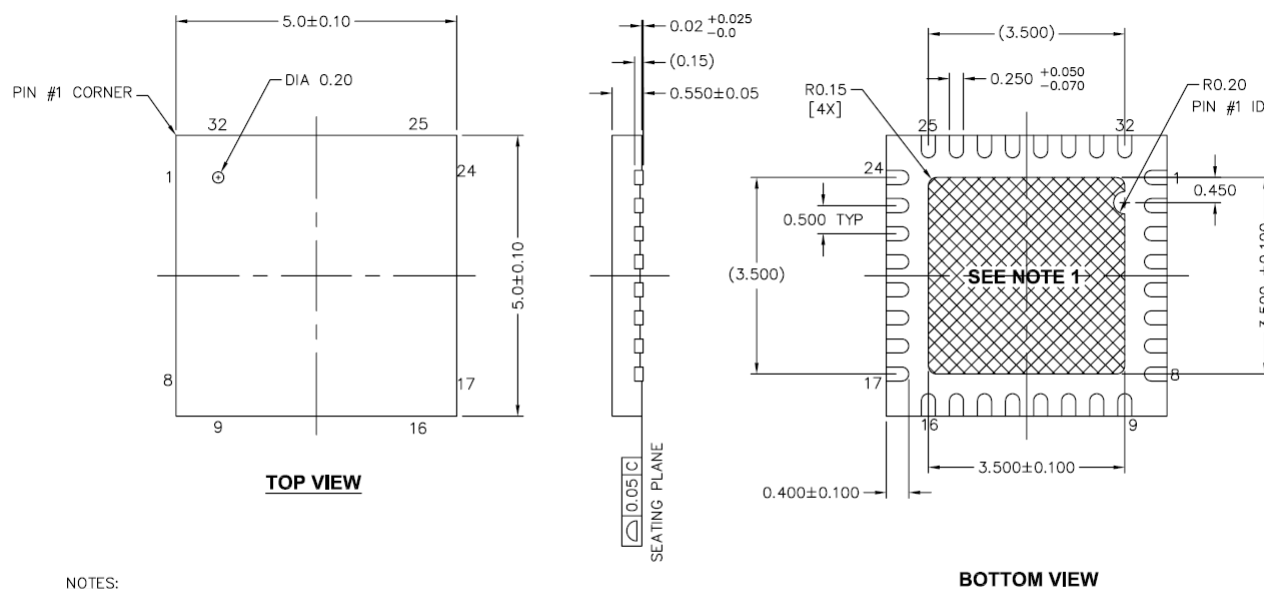


NOTES :

1.  HATCH IS SOLDERABLE EXPOSED METAL.
2. REFERENCE JEDEC # MO-248
3. PACKAGE WEIGHT : 29 ± 3 mg
4. ALL DIMENSIONS ARE IN MILLIMETERS

001-13937 *E

Figure 14. 32-Pin ($5 \times 5 \times 0.55$ mm) QFN

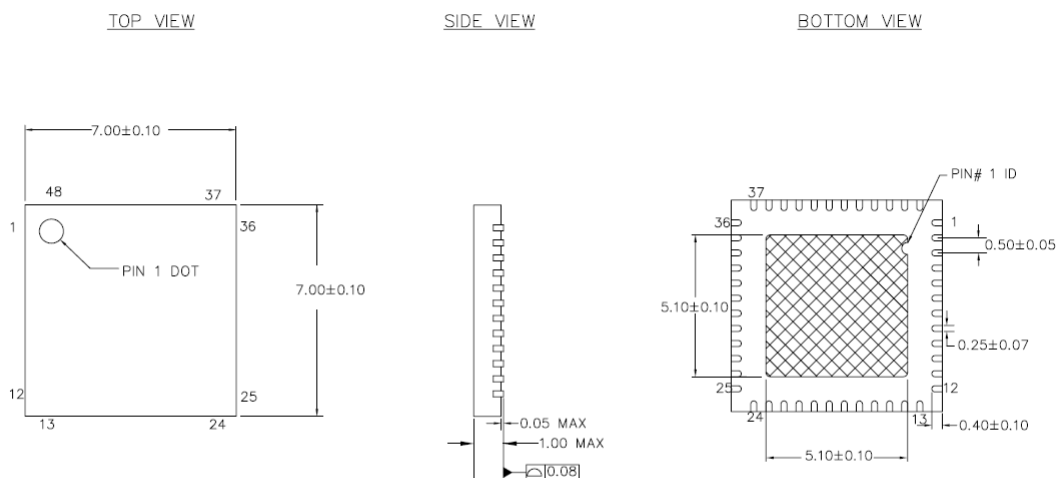


NOTES:

1. HATCH AREA IS SOLDERABLE EXPOSED PAD
2. BASED ON REF JEDEC # MO-248
3. PACKAGE WEIGHT: 0.0388g
4. DIMENSIONS ARE IN MILLIMETERS

001-42168 *E

Figure 15. 48-Pin ($7 \times 7 \times 1.0$ mm) QFN



NOTES:

1. HATCH AREA IS SOLDERABLE EXPOSED METAL.
2. REFERENCE JEDEC#: MO-220
3. PACKAGE WEIGHT: 13 ± 1 mg
4. ALL DIMENSIONS ARE IN MILLIMETERS

001-13191 *G

Important Notes

- For information on the preferred dimensions for mounting QFN packages, see the following Application Note at http://www.amkor.com/products/notes_papers/MLFAppNote.pdf.
- Pinned vias for thermal conduction are not required for the low power PSoC device.

Development Tool Selection

Software

PSoC Designer

At the core of the PSoC development software suite is PSoC Designer. Utilized by thousands of PSoC developers, this robust software has been facilitating PSoC designs for over half a decade. PSoC Designer is available free of charge at <http://www.cypress.com>.

PSoC Programmer

Flexible enough to be used on the bench in development, yet suitable for factory programming, PSoC Programmer works either as a standalone programming application or it can operate directly from PSoC Designer. PSoC Programmer software is compatible with both PSoC ICE-Cube In-Circuit Emulator and PSoC MiniProg. PSoC Programmer is available free of charge at <http://www.cypress.com>.

Development Kits

All development kits are sold at the Cypress Online Store.

CY3215-DK Basic Development Kit

The **CY3215-DK** is for prototyping and development with PSoC Designer. This kit supports in-circuit emulation and the software interface enables users to run, halt, and single step the processor and view the content of specific memory locations. PSoC Designer supports the advance emulation features also. The kit includes:

- PSoC Designer software CD
- ICE-Cube In-Circuit Emulator
- ICE Flex-Pod for CY8C29x66A family
- Cat-5 adapter
- Mini-Eval programming board
- 110 ~ 240-V power supply, Euro-Plug adapter
- iMAGEcraft C Compiler (Registration required)
- ISSP cable
- USB 2.0 cable and Blue Cat-5 cable
- Two CY8C29466A-24PXI 28-PDIP chip samples

Evaluation Tools

All evaluation tools are sold at the Cypress Online Store.

CY3210-MiniProg1

The **CY3210-MiniProg1** kit enables the user to program PSoC devices via the MiniProg1 programming unit. The MiniProg is a small, compact prototyping programmer that connects to the PC via a provided USB 2.0 cable. The kit includes:

- MiniProg Programming Unit
- MiniEval Socket Programming and Evaluation Board
- 28-pin CY8C29466A-24PXI PDIP PSoC Device Sample
- 28-pin CY8C27443A-24PXI PDIP PSoC Device Sample
- PSoC Designer Software CD
- Getting Started Guide
- USB 2.0 Cable

CY3210-PSoCEval1

The **CY3210-PSoCEval1** kit features an evaluation board and the MiniProg1 programming unit. The evaluation board includes an LCD module, potentiometer, LEDs, and plenty of bread-boarding space to meet all of your evaluation needs. The kit includes:

- Evaluation Board with LCD Module
- MiniProg Programming Unit
- 28-pin CY8C29466A-24PXI PDIP PSoC Device Sample (2)
- PSoC Designer Software CD
- Getting Started Guide
- USB 2.0 Cable

CY3280-20x66 Universal CapSense Controller

The **CY3280-20X66 CapSense Controller Kit** is designed for easy prototyping and debug of CY8C20xx6A CapSense Family designs with pre-defined control circuitry and plug-in hardware. Programming hardware and an I2C-to-USB bridge are included for tuning and data acquisition.

The kit includes:

- CY3280-20x66 CapSense Controller board
- CY3240-I2USB bridge
- CY3210 MiniProg1 Programmer
- USB 2.0 retractable cable
- CY3280-20x66 Kit CD

Glossary

Crosspoint connection	Connection between any GPIO combination via analog multiplexer bus.
Differential non-linearity	Ideally, any two adjacent digital codes correspond to output analog voltages that are exactly one LSB apart. Differential non-linearity is a measure of the worst case deviation from the ideal 1 LSB step.
Hold time	Hold time is the time following a clock event during which the data input to a latch or flip-flop must remain stable in order to guarantee that the latched data is correct.
I²C	It is a serial multi-master bus used to connect low speed peripherals to MCU.
Integral nonlinearity	It is a term describing the maximum deviation between the ideal output of a DAC/ADC and the actual output level.
Latch up current	Current at which the latch up test is conducted according to JESD78 standard (at 125 °C)
Power supply rejection ratio (PSRR)	The PSRR is defined as the ratio of the change in supply voltage to the corresponding change in output voltage of the device.
Scan	The conversion of all sensor capacitances to digital values.
Setup time	Period required to prepare a device, machine, process, or system for it to be ready to function.
Signal-to-noise ratio	The ratio between a capacitive finger signal and system noise.
SPI	Serial peripheral interface is a synchronous serial data link standard.

Reference Documents

- Technical reference manual for [CY8C20xx6](#) devices
- In-system Serial Programming (ISSP) protocol for 20xx6 – [AN2026C](#)
- Host Sourced Serial Programming for 20xx6 devices – [AN59389](#)

Document History Page

Document Title: CY8C20336H/CY8C20446H Haptics Enabled CapSense® Controller Document Number: 001-56223				
Revision	ECN	Origin of Change	Submission Date	Description of Change
**	2787411	VZD/AESA	10/15/2009	New datasheet.
*A	3016550	KEJO/KPOL	08/26/2010	Added CY8C20346H part. Updated 24-pin QFN and 32-pin QFN package diagrams. Content and format updated to match latest template.
*B	3089844	JPM	11/18/10	In Table 26 , modified T_{LOW} and T_{HIGH} min values to 42. Updated T_{SS_HIGH} min value to 50; removed max value.
*C	3180479	YVA	02/23/11	Removed CY8C20346H part Changed title from CapSense Applications to Haptics Enabled CapSense Controller Updated Table 29 with Time at Maximum Temperature information
*D	3638625	YLIU/BVI	06/06/2012	Updated F_{SCLK} parameter in the SPI Slave AC Specifications table Updated Getting Started and Designing with PSoC Designer sections. Included Development Tools . Updated Software under Development Tool Selection section. Updated F_{SCLK} parameter in the Table 26 , "SPI Slave AC Specifications," on page 24. Changed t_{OUT_HIGH} to t_{OUT_H} in Table 25 , "SPI Master AC Specifications," on page 23 Updated package diagrams: 001-13937 to *D 001-13191 to *F
*E	3822568	DST	11/27/2012	Updated package diagrams: 001-13937 to *E 001-42168 to *E 001-13191 to *G

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